



Features:

- DC 6.0 GHz
- 5 Watts
- BeO Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested

Chip Termination 5 Watts, 50Ω

General Specifications

Resistive Element Thick film

SubstrateBeryllium oxide ceramicTerminalsMatte Tin over Nickel

Electrical Specifications

Resistance Range: 50 ohms, \pm 2% **Frequency Range;** DC - 6.0 GHz

Power: 5 Watts

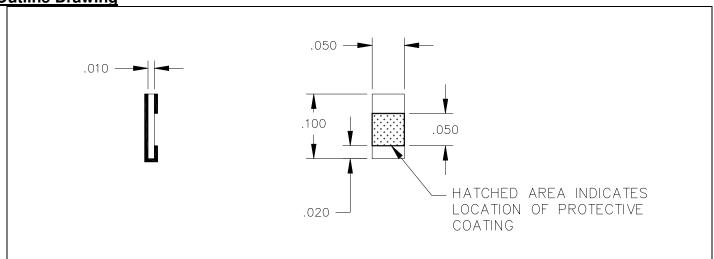
VSWR 1.25:1 DC – 6.0 GHz

Note: Tolerance is ± 0.010 ", unless otherwise specified. Designed to meet of exceed applicable portions of MIL-E-5400. Operating temperature is -55°C to 150°C (see chart for derating temperatures).

All dimensions in inches.

Specifications subject to change with out notice.

Outline Drawing



050100-1X50-2 (097) Rev A



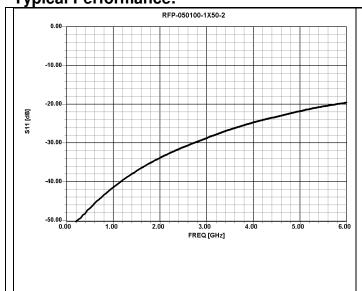


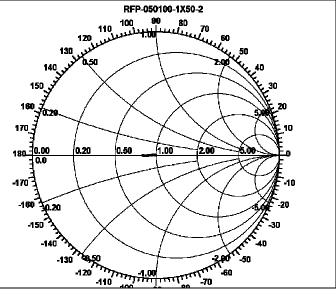
Available on Tape and Reel For Pick and Place Manufacturing. USA/Canada: (315) 432-8909 Toll Free: (800) 544-2414 Europe: +44 2392-232392





Typical Performance:

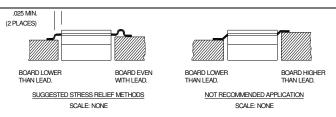




Power De-rating:

POWER DERATING POWER 100 75 RATED 50 25 Ы 0 25 50 75 100 125 150 P.C.B. SOLDER INTERFACE TEMPERATURE-C

Mounting Footprint and Procedure:



SUGGESTED MOUNTING PROCEDURES:

- MAKE SURE THAT THE DEVICES ARE MOUNTED ON FLAT SURFACES (.001" UNDER THE DEVICE) TO OPTIMIZE THE HEAT TRANSFER.
- 2. DRILL & TAP THE HEATSINK FOR THE APPROPRIATE THREAD SIZE TO BE USED.
- 3. COAT HEATSINK WITH A MINIMUM AMOUNT OF HIGH QUALITY SILICONE GREASE (.001" MAX. THICKNESS).
- 4. POSITION DEVICE ON MOUNTING SURFACE & SECURE USING SOCKET HEAD SCREWS, FLAT & SPLIT WASHER. TORQUE SCREWS TO THE APPROPRIATE VALUE. MAKE SURE THAT THE DEVICE IS FLAT AGAINST THE HEATSINK. (CARE SHOULD BE TAKEN TO AVOID UPWARD PRESSURE OF THE LEADS TOWARDS THE LID).
- 5. SOLDER LEADS IN PLACE USING APPROPROATE SOLDER WITH A CONTROLLED TEMPERATURE IRON.

** FOR MORE DETAILS CONTACT FACTORY **

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